

MINIATURE CARD – MICRO SD CONNECTOR

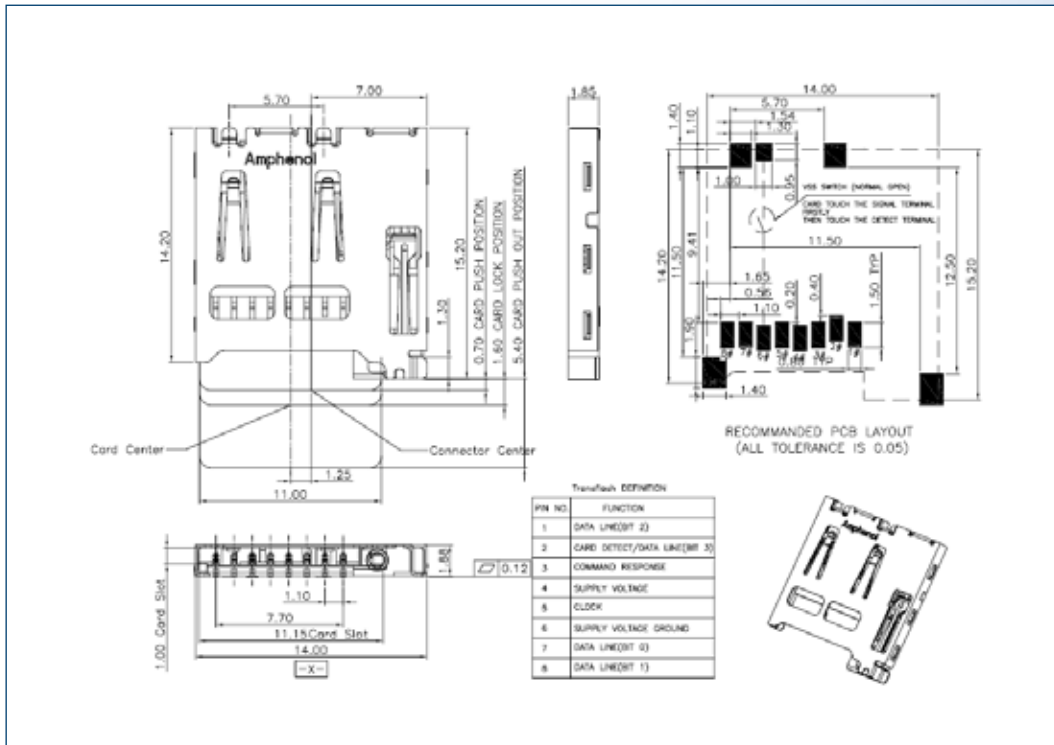


Specifications:

Contact Resistance: 100 mΩ max at 100 mA
Insulation Resistance: 1000 MΩ min at 500 VDC
Voltage rating: 100V AC
Current Rating: 0.5 A per contact
Dielectric Strength: 500 VAC/RMS initial and 250 VAC final at 60 Hz for 1 minute
Operating Temperature: -25°C to +85°C

Materials:

Housing: High Temperature thermoplastic, UL94V-0 rated
Contact: Copper alloy with selective Au plating, Tin plated on solder tail
Cover: Copper alloy nickel overall



Part Numbers:

P/N	Description
101-00112-68	Micro-SD 8P p-p, w/o C/D, 15 u" Au plated
101-00139-64	Micro-SD 9P p-p, w/ C/D, 1 u" Au plated
101-00139-68	Micro-SD 9P p-p, w/ C/D, 15 u" Au plated
101-00139-69	Micro-SD 9P p-p, w/ C/D, 30 u" Au plated
101-00240-64	Micro-SD 8P, manual, w/ C/D, 1 u" Au plated
101-00240-68	Micro-SD 8P, manual, w/ C/D, 15 u" Au plated
101-00240-69	Micro-SD 8P, manual, w/ C/D, 30 u" Au plated
101-00349-64	Micro-SD 9P p-p, w/ C/D, 1 u" Au plated
101-00349-68	Micro-SD 9P p-p, w/ C/D, 15 u" Au plated
101-00349-69	Micro-SD 9P p-p, w/ C/D, 30 u" Au plated
101-00303-68	Micro SD Hinge Type, 15 u" Au plated
101-00581-59	Micro-SD p-p w/ C/D (Normal Close), 20u" Au plated